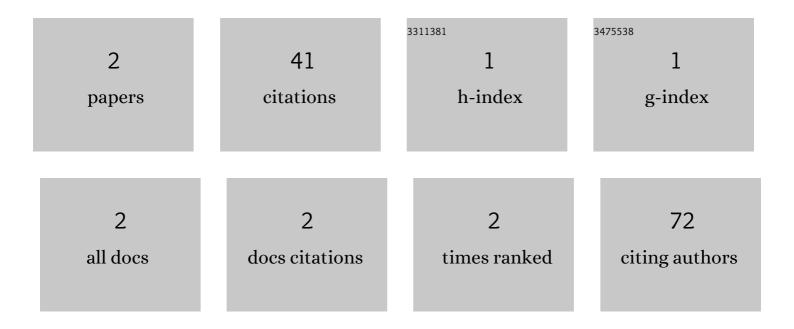
## Mingxing Du

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/9259383/publications.pdf Version: 2024-02-01



#	Article	IF	CITATIONS
1	An Adaptive Thermal Equivalent Circuit Model for Estimating the Junction Temperature of IGBTs. IEEE Journal of Emerging and Selected Topics in Power Electronics, 2019, 7, 392-403.	5.4	41
2	Junction temperature estimation approach based on TSEPs in multichip IGBT modules. Journal of Power Electronics, 0, , .	1.5	0